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L. BESSER
COMSAT General Integrated Syst.
1131 San Antonio Rd.
Palo Alto, CA 94303

Submillimeter-Wave Techniques

K. J. BUTTON
Bldg. NW-14
Massachusetts Inst. Technol.
Cambridge, MA 02133

Microwave and Millimeter-Wave Solid-State Devices

E. D. COHEN
Naval Electronic Systems Comd.
Code 61V
National Center #1
Washington, DC 20360

H. J. KUNO
Hughes Aircraft Co.
3100 W. Lomita Blvd.
Torrance, CA 90509

Microwave Ferrites

C. R. BOYD, JR.
Microwave Applications Group
3030 Industrial Parkway
Santa Maria, CA 93455

Microwave Systems

F. IVANEK
Farion Electric Operation
Harris Corp.
1691 Bayport Ave.
San Carlos, CA 94070

Microwave Network Theory

A. E. WILLIAMS
COMSAT LABS
22300 Comsat Dr.
Clarksburg, MD 20734

Microwave Acoustics

R. S. KAGIWADA
TRW Defense and Space Syst. Group
Elec. Syst. Div.
1 Space Park
Redondo Beach, CA 90278

Microwave High-Power Techniques

H. GOLDIE
Westinghouse Electric Corp.
Advanced Technology Labs.
P.O. Box 1521, MS-3716
Baltimore, MD 21203

Biological Effects and Medical Applications

O. P. GANDHI
Dep. Elec. Eng.
Univ. Utah
Salt Lake City, UT 84112

Microwave Low Noise Techniques

J. J. WHELEHAN, JR.
Eaton Corp. AIL Div.
Walt Whitman Rd.
Melville, NY 11747

Digital Microwave Systems

P. T. GREILING
Hughes Res. Labs.
3011 Malibu Canyon Rd.
Malibu, CA 90265

Fiber and Integrated Optics

W. S. C. CHANG
Dep. Elec. Eng. and Computer Sci.
C-014
Univ. California, San Diego
La Jolla, CA 92093

Microwave and Millimeter-Wave Integrated Circuits

D. K. MAKI
Hughes Aircraft Co.
Bldg. 231/2019
3100 W. Lomita Blvd.
P.O. Box 2999
Torrance, CA 90509

Microwave Measurements

H. G. OLTMAN, JR.
Hughes Aircraft Co.
Bldg. 268/A54
8433 Fallbrook Ave.
Canoga Park, CA 91304

Microwave Field Theory

T. ITOH
Dep. Elec. Eng.
The Univ. Texas, Austin, Box 7728
Austin, TX 78712

Automatic RF Techniques

M. A. MAURY, JR.
Maury Microwave Corp.
8610 Helms Ave.
Cucamonga, CA 91730

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U. S. Naval Res. Lab.
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